

Ultramid® A3HG5

Polyamide 66

Product Description

Ultramid A3HG5 is a 25% glass fiber reinforced injection molding PA66 grade.

Applications

Typical applications include machinery components and housings of high stiffness and dimensional stability.

PHYSICAL	ISO Test Method	Property Value	
Density, g/cm ³	1183	1.32	
Moisture, %	62		
(50% RH)		1.9	
(Saturation)		6	
RHEOLOGICAL	ISO Test Method	Dry	Conditioned
Melt Volume Rate (275 C/5 Kg), cc/10min.	1133	50	-
MECHANICAL	ISO Test Method	Dry	Conditioned
Tensile Modulus, MPa	527		
23C		8,600	6,500
Tensile stress at break, MPa	527		
-40C		196	186
23C		170	120
Tensile strain at break, %	527		
-40C		2.9	2.7
23C		3.0	6.0
Flexural Modulus, MPa	178		
23C		7,600	-
IMPACT	ISO Test Method	Dry	Conditioned
Izod Notched Impact, kJ/m ²	180		
23C		9.5	-
Charpy Notched, kJ/m ²	179		
-30C		9	-
23C		10	18
Charpy Unnotched, kJ/m ²	179		
-30C		55	-
23C		65	90
THERMAL	ISO Test Method	Dry	Conditioned
Melting Point, C	3146	260	-
HDT A, C	75	250	-
HDT B, C	75	250	-
Coef. of Linear Thermal Expansion, Parallel, mm/mm C		0.3 X10 ⁻⁴	-
Coef. of Linear Thermal Expansion, Normal, mm/mm C		0.65 X10 ⁻⁴	-
ELECTRICAL	ISO Test Method	Dry	Conditioned

Comparative Tracking Index	IEC 60112	550	550
Volume Resistivity (Ohm-m)	IEC 60093	1E13	1E10
Dielectric Constant (1 MHz)	IEC 60250	3.5	5.5
Dissipation Factor (100 Hz), E-4	IEC 60250	140	3,000
Dissipation Factor (1 MHz), E-4	IEC 60250	140	1,600

UL RATINGS	UL Test Method	Property Value
Flammability Rating, 0.8mm	UL94	HB
Relative Temperature Index, 0.8mm	UL746B	
Electrical, C		130
Flammability Rating, 1.5mm	UL94	HB
Relative Temperature Index, 1.5mm	UL746B	
Mechanical w/o Impact, C		130
Mechanical w/ Impact, C		120
Electrical, C		130
Flammability Rating, 3.0mm	UL94	HB
Relative Temperature Index, 3.0mm	UL746B	
Mechanical w/o Impact, C		130
Mechanical w/ Impact, C		120
Electrical, C		130

Processing Guidelines

Material Handling

Max. Water content: 0.15%
 Product is supplied in sealed containers and drying prior to molding is not required. If drying becomes necessary, a dehumidifying or desiccant dryer operating at 80C (176F) is recommended. Drying time is dependent on moisture level, However 2-4 hours is generally sufficient. Recommended moisture levels for achieving optimum surface qualities and mechanical properties is 0.05% - 0.12%. Further information concerning safe handling procedures can be obtained from the Safety Data Sheet. Alternatively, please contact your BASF representative.

Typical Profile

Melt Temperature 280-305C (536-581F)
 Mold Temperature 80-90C (176-194F)
 Injection and Packing Pressure 35-125 bar (500-1500 psi)

Mold Temperatures

A mold temperature of 80-90C (176-194F) is recommended, however temperatures of as low as 45C (113F) and as high as 105C (221F) can be used where applicable.

Pressures

Injection pressure controls the filling of the part and should be applied for 90% of ram travel. Packing pressure affects the final part and can be used effectively in controlling sink marks and shrinkage. It should be applied and maintained until the gate area is completely frozen off.

Back pressure can be utilized to provide uniform melt consistency and reduce trapped air and gas. Minimal back pressure should be utilized to prevent glass breakage.

Fill Rate

Fast fill rates are recommended to ensure uniform melt delivery to the cavity and prevent premature freezing. Surface appearance is directly affected by injection rate.

Note

Note

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